# onsemi

## **MOSFET** – Power, Dual, N-Channel, for 1-Cell Lithium-ion Battery Protection

## 12 V, 7.1 mΩ, 14 A

## EFC2J004NUZ

This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

## Features

- 2.5 V Drive
- 2 kV ESD HBM
- Common-Drain Type
- ESD Diode-Protected Gate
- Pb-Free, Halide Free and RoHS Compliant

## Applications

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

## Specifications

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Parameter	Symbol	Value	Unit
Source to Source Voltage	V <sub>SSS</sub>	12	V
Gate to Source Voltage	V <sub>GSS</sub>	±8	V
Source Current (DC)	I <sub>S</sub>	14	А
Source Current (Pulse) PW $\leq$ 100 $\mu$ s, duty cycle $\leq$ 1%	I <sub>SP</sub>	60	A
Total Dissipation (Note 1)	PT	1.5	W
Junction Temperature	Тj	150	°C
Storage Temperature	T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

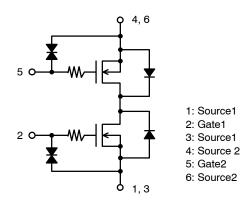
## THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient (Note 1)	$R_{\thetaJA}$	83	°C/W

1. Surface mounted on ceramic substrate (5000  $\text{mm}^2 \times 0.8$  mm).

V <sub>SSS</sub>	R <sub>SS(on)</sub> Max	I <sub>S</sub> Max
12 V	7.1 mΩ @ 4.5 V	14 A
	7.7 mΩ @ 3.8 V	
	9.5 mΩ @ 3.1 V	
	12.4 mΩ @ 2.5 V	

### ELECTRICAL CONNECTION N-Channel







N

Y

MARKING DIAGRAM

WLCSP6, 2.11x1.18x0.10 CASE 567NP

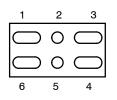
٨V	= Device Code	

NA

AYWZZ

- A = Assembly Location
  - = Year
- W = Work Week
- ZZ = Assembly Lot Number
  - = Pb-Free Package

## **PIN CONNECTIONS**



1: Source1 2: Gate1



- 4: Source 2
- 5: Gate2
- 6: Source2

## ORDERING INFORMATION

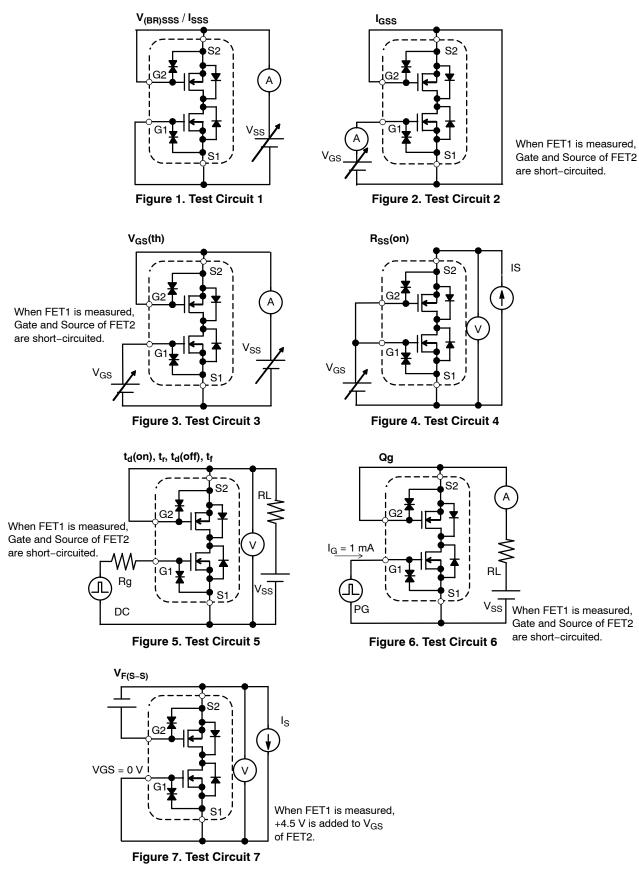
See detailed ordering and shipping information on page 6 of this data sheet.

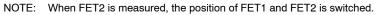
Parameter Symbol Conditions		Conditions	Min	Тур	Max	Unit
Source to Source Breakdown Voltage	V <sub>(BR)SSS</sub>	$I_S = 1 \text{ mA}, V_{GS} = 0 \text{ V}$ (Figure 1)	12	-	-	V
Zero-Gate Voltage Source Current	I <sub>SSS</sub>	$V_{SS}$ = 10 V, $V_{GS}$ = 0 V (Figure 1)	-	-	1	μA
Gate to Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 8 \text{ V}, V_{SS} = 0 \text{ V}$ (Figure 2)	-	-	±1	μA
Gate Threshold Voltage	V <sub>GS</sub> (th)	$V_{SS} = 6 V$ , $I_S = 1 mA$ (Figure 3)	0.4	-	1.3	V
Static Source to Source On-State	R <sub>SS</sub> (on)	$I_S = 5 \text{ A}, V_{GS} = 4.5 \text{ V}$ (Figure 4)	3.7	5.4	7.1	mΩ
Resistance (Note 2)		$I_S = 5 \text{ A}, V_{GS} = 3.8 \text{ V}$ (Figure 4)	4.1	5.9	7.7	mΩ
		$I_S = 5 \text{ A}, V_{GS} = 3.1 \text{ V}$ (Figure 4)	4.6	6.7	9.5	mΩ
		$I_S = 5 \text{ A}, V_{GS} = 2.5 \text{ V}$ (Figure 4)	5.8	8.4	12.4	mΩ
Turn-ON Delay Time	t <sub>d</sub> (on)	$V_{SS} = 5 V, V_{GS} = 3.8 V, I_{S} = 5 A,$	-	15	-	μs
Rise Time	t <sub>r</sub>	$R_g = 10 k\Omega$ (Figure 5)	-	35	-	μs
Turn-OFF Delay Time	t <sub>d</sub> (off)		-	100	-	μs
Fall Time	t <sub>f</sub>		-	75	-	μs
Total Gate Charge	Qg	$V_{SS} = 6 \text{ V}, V_{GS} = 4.5 \text{ V}, I_S = 14 \text{ A}$ (Figure 6)	-	36	-	nC
Forward Source to Source Voltage	V <sub>F(S-S)</sub>	$I_S = 3 \text{ A}, V_{GS} = 0 \text{ V}$ (Figure 7)	-	0.76	-	V

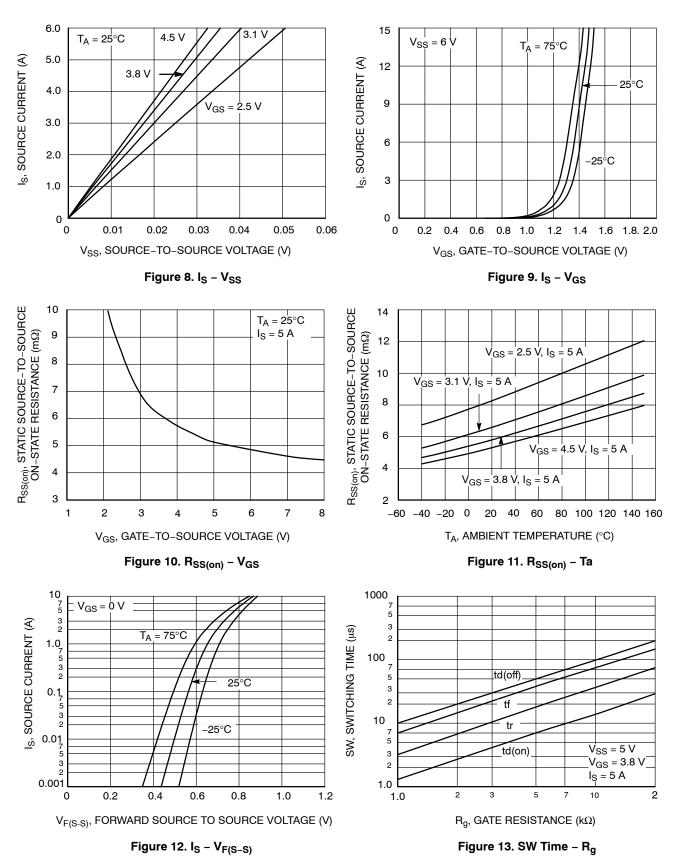
## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C) (Note 2)

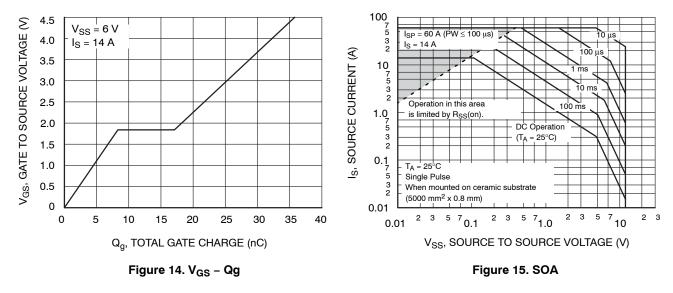
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Mounted on **onsemi** board.

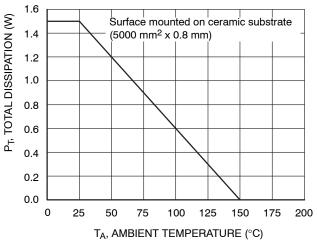
#### Test Circuits are Example of Measuring FET1 Side

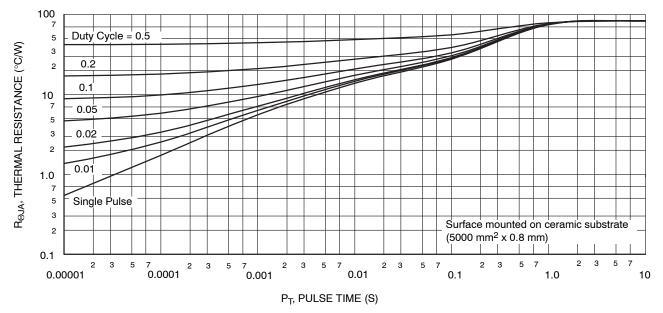














## **ORDERING INFORMATION**

Device	Marking	Package	Shipping $^{\dagger}$ (Qty / Packing)
EFC2J004NUZTDG	NA	WLCSP6, 2.11x1.18x0.10 (Pb-Free / Halogen Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

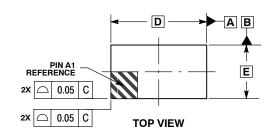
Note on usage: Since the EFC2J004NUZ is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.



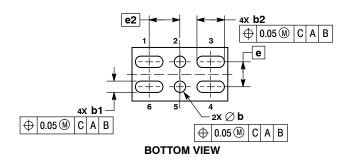


WLCSP6, 2.11x1.18x0.10 CASE 567NP **ISSUE B** 

#### DATE 22 DEC 2016







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1.	. DIMENSIONING AND TOLERANCING PER							
	ASME Y14.5M, 1994.							
2.	2. CONTROLLING DIMENSION: MILLIMETERS.							
		МІ	LLIMETE	RS	]			
	DIM	MIN	NOM	MAX				
	Α	0.08	0.10	0.12				
	b	0.22	0.25	0.28				
	b1	0.27	0.30	0.33				
	<b>b2</b> 0.575 0.605 0.635							
	D	2.11 BSC						
	E	1.18 BSC						
	е		0.55 BSC	;				
	e2	0	.6775 BS	С	]			

#### GENERIC **MARKING DIAGRAM\***

XXXXX=
AYWZZ∎
0

= Assembly Location A

Y = Year

NOTES

= Work Week W

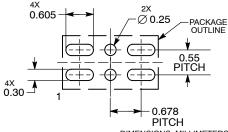
ZZ = Assembly Lot

= Pb-Free Package .

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

#### RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	WLCSP6, 2.11X1.18X0.10 PAGE		PAGE 1 OF 1		
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